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# RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : S124

DEVICE : R7FS124XXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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## Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $^{\circ}$ C to 150 $^{\circ}$ C , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



## Table. Reliability test results (QFN)

Test Items Reference		Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



### Table. Reliability test results (LGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)		Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ to 125 $^{\circ}$ , 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3

#### Note:

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>•</sup>It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

#### •Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 3.8 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term ( $\pi$ T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV) Ta: Ambient temperature ( $^{\circ}$ C)

πΤsim	$\pi$ T simplified chart as Ea=0.7 eV											
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

### ·MTTF ( Mean Time To Failure )

$$MTTF = 1/\lambda$$



#### Reference about Renesas package code

Package type		Package code *1
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

<sup>\*1.</sup> First four digit

#### Table. Product list

	. Product lis	ι					
	Group	Product part number	Package code	No	Group	Product part number	Package code
1	S124	R7FS124763A01CFL	PLQP0048K*	51			
2	S124	R7FS124773A01CFL	PLQP0048K*	52			
3	S124	R7FS124763A01CFM	PLQP0064K*	53			
4	S124	R7FS124773A01CFM	PLQP0064K*	54			
5	S124	R7FS124762A01CLM	PWLG0036K*	55			
6	S124	R7FS124772A01CLM	PWLG0036K*	56			
7	S124	R7FS124763A01CNB	PWQN0064L*	57			
8	S124	R7FS124773A01CNB	PWQN0064L*	58			
9	S124	R7FS124763A01CNE	PWQN0048K*	59			
	S124	R7FS124773A01CNE	PWQN0048K*	60			
	S124	R7FS124763A01CNF	PWQN0040K*	61			
	S124	R7FS124773A01CNF	PWQN0040K*	62			
13				63			
14				64			
15				65			
16				66			
17				67		1	
18				68			
19				69			
20				70			
21				71			
22				72			
23				73			
24				74			
25 26				75 76			
27				77			
28				78			
29				79			
30				80			
31				81			
32				82			
33				83			
34				84			
35				85			
36				86			
37				87			
38				88			
39				89			
40				90			
41				91			
42				92			
43				93			
44				94			
45				95			
46				96			
47				97			
48				98			
				99	1		
49				22			